# UNISONIC TECHNOLOGIES CO., LTD

2N60-TD **Power MOSFET** 

# 2A, 600V N-CHANNEL **POWER MOSFET**

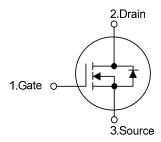
#### **DESCRIPTION**

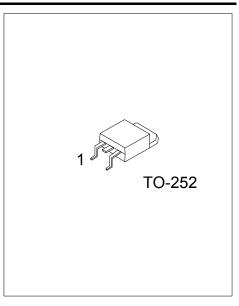
The UTC 2N60-TD is a high voltage power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

# **FEATURES**

- \*  $R_{DS(ON)} \le 4.5 \Omega @ V_{GS} = 10V, I_D = 1.0A$
- \* Fast switching capability
- \* Avalanche energy tested
- \* Improved dv/dt capability, high ruggedness

### **SYMBOL**

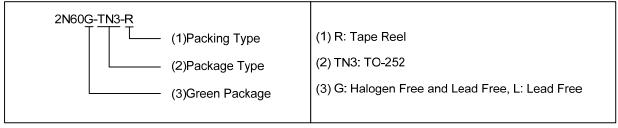




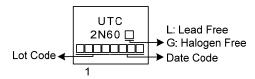
#### ORDERING INFORMATION

Ordering Number		Daalaasa	Pin	Assignm	Doolsing		
Lead Free	Halogen Free	Package	1	2	3	Packing	
2N60L-TN3-R	2N60G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



### **MARKING**



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# ■ **ABSOLUTE MAXIMUM RATINGS** (T<sub>C</sub> = 25°C, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	$V_{DSS}$	600	V
Gate-Source Voltage	$V_{GSS}$	±30	V
Continuous Drain Current	I <sub>D</sub>	2	Α
Pulsed Drain Current (Note 2)	I <sub>DM</sub>	4	Α
Avalanche Energy Single Pulsed (Note 3)	E <sub>AS</sub>	77	mJ
Peak Diode Recovery dv/dt (Note 4)	dv/dt	3.4	V/ns
Power Dissipation	P <sub>D</sub>	38	W
Junction Temperature	ΤJ	+150	°C
Storage Temperature	T <sub>STG</sub>	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 30mH,  $I_{AS}$  = 2.26A,  $V_{DD}$  = 50V,  $R_G$  = 25  $\Omega$ , Starting  $T_J$  = 25°C
- 4.  $I_{SD} \le 2.0$ A, di/dt  $\le 200$ A/ $\mu$ s,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25$ °C

# ■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	$\theta_{JA}$	110	°C/W	
Junction to Case	$\theta_{JC}$	3.28 (Note)	°C/W	

Note: Device mounted on FR-4 substrate P<sub>C</sub> board, 2oz copper, with 1inch square copper plate.

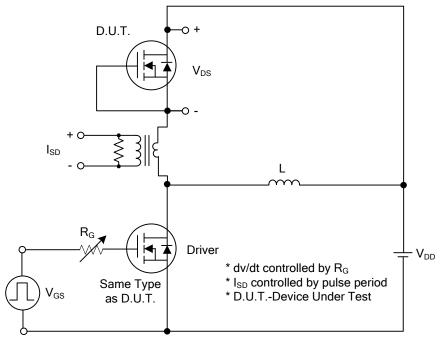
# ■ **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS		TYP	MAX	UNIT
OFF CHARACTERISTICS		_		ā.		ā.	
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	$V_{GS} = 0V, I_D = 250\mu A$	600			V
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> = 600V, V <sub>GS</sub> = 0V			10	μΑ
Gate- Source Leakage Current	Forward	I <sub>GSS</sub>	$V_{GS} = 30V, V_{DS} = 0V$			100	nA
	Reverse	IGSS	$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	$V_{GS} = 10V, I_D = 1.0A$			4.5	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		C <sub>ISS</sub>			234		pF
Output Capacitance		Coss	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1.0 MHz		30		pF
Reverse Transfer Capacitance		C <sub>RSS</sub>			3.4		pF
SWITCHING CHARACTERISTICS	S	_		ā.		ā.	
Total Gate Charge (Note 1)		$Q_G$	1/ 400// 1/ 40// 1 4.04		11.4		nC
Gate-Source Charge		$Q_GS$	V <sub>DS</sub> =480V, V <sub>GS</sub> =10V, I <sub>D</sub> =1.0A,		4		nC
Gate-Drain Charge		$Q_GD$	I <sub>D</sub> =1mA (Note 1, 2)		1.6		nC
Turn-On Delay Time (Note 1)		t <sub>D(ON)</sub>			4.6		ns
Turn-On Rise Time		t <sub>R</sub>	$V_{DD}$ =100V, $V_{GS}$ =10V, $I_{D}$ =2.0A,		15.6		ns
Turn-Off Delay Time		t <sub>D(OFF)</sub>	$R_G = 25\Omega$ (Note 1, 2)		21.8		ns
Turn-Off Fall Time		t <sub>F</sub>			26		ns
DRAIN-SOURCE DIODE CHARA	CTERISTIC	CS AND MA	XIMUM RATINGS				
Maximum Body-Diode Continuous Current		Is				1	Α
Maximum Body-Diode Pulsed Current		I <sub>SM</sub>				2	Α
Drain-Source Diode Forward Voltage		$V_{SD}$	I <sub>S</sub> =2.0A , V <sub>GS</sub> =0V			1.4	V
Body Diode Reverse Recovery Time		t <sub>rr</sub>	1 = 2 0 A		195		ns
Body Diode Reverse Recovery Charge		Qrr	I <sub>S</sub> =2.0A , V <sub>GS</sub> =0V di/dt=100A/μs		1.7		μC

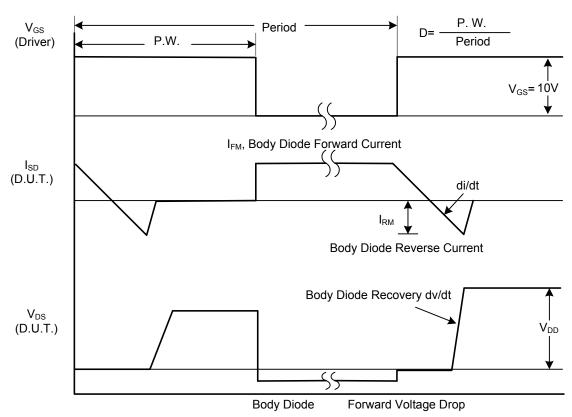
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

2. Essentially independent of operating temperature.

# **■ TEST CIRCUITS AND WAVEFORMS**



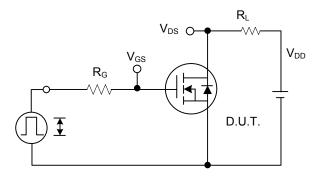
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

2N60-TD Power MOSFET

# **■ TEST CIRCUITS AND WAVEFORMS**



V<sub>DS</sub> 90%

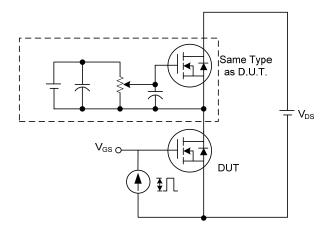
V<sub>GS</sub> 10%

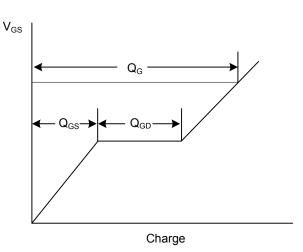
t<sub>D(ON)</sub>

t<sub>R</sub> →

**Switching Test Circuit** 

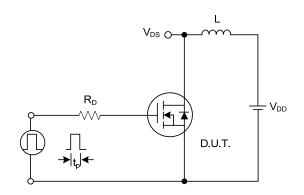
**Switching Waveforms** 

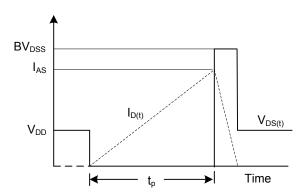




**Gate Charge Test Circuit** 

**Gate Charge Waveform** 

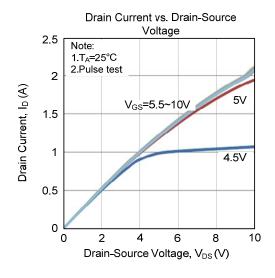


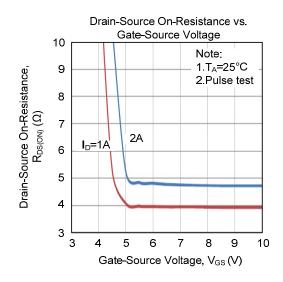


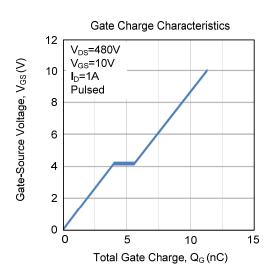
**Unclamped Inductive Switching Test Circuit** 

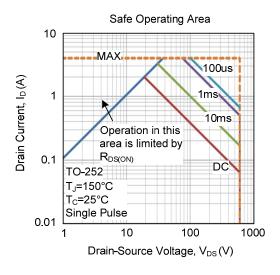
**Unclamped Inductive Switching Waveforms** 

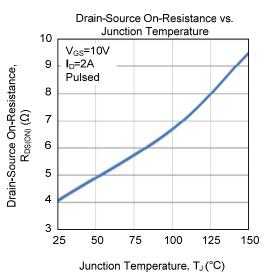
# **■ TYPICAL CHARACTERISTICS**

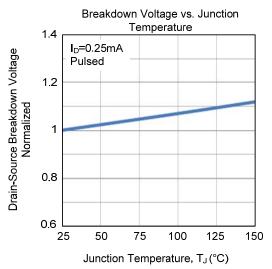




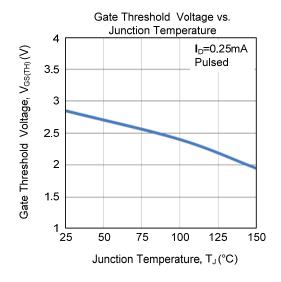


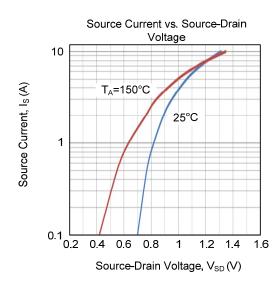


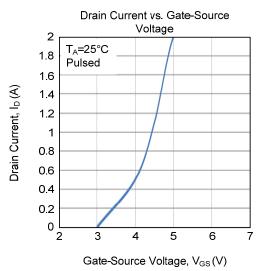


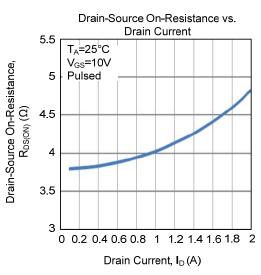


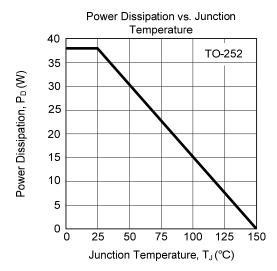
# **■ TYPICAL CHARACTERISTICS (Cont.)**

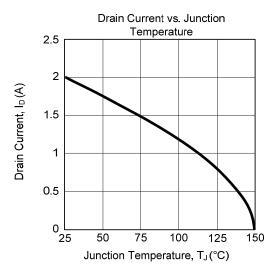












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